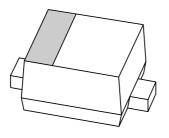
## DISCRETE SEMICONDUCTORS

# DATA SHEET



## BAP1321-01 Silicon PIN diode

Preliminary specification

2001 Nov 01





## Silicon PIN diode BAP1321-01

### **FEATURES**

- High voltage, current controlled
- RF resistor for RF attenuators and switches
- Low diode capacitance
- Low diode forward resistance
- Very low series inductance
- For applications up to 3 GHz.

## **APPLICATIONS**

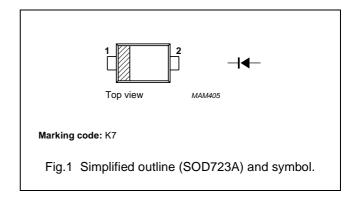
• RF attenuators and switches.

## **DESCRIPTION**

Planar PIN diode in a SOD723A ultra small plastic SMD package.

### **PINNING**

PIN	DESCRIPTION
1	cathode
2	anode



### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>R</sub>	continuous reverse voltage		_	60	V
I <sub>F</sub>	continuous forward current		_	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>s</sub> = 90 °C	_	315	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

Philips Semiconductors Preliminary specification

Silicon PIN diode BAP1321-01

## **ELECTRICAL CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 50 mA	0.95	1.1	V
I <sub>R</sub>	reverse leakage current	V <sub>R</sub> = 60 V	_	0.1	μΑ
		V <sub>R</sub> = 20 V	_	tbd	μΑ
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 0; f = 1 MHz	0.32	_	pF
		$V_R = 1 V$ ; $f = 1 MHz$	0.28	_	pF
		$V_R = 20 \text{ V}; f = 1 \text{ MHz}$	0.22	0.32	pF
$r_D$	diode forward resistance	f = 100 MHz; note 1			
		$I_F = 0.5 \text{ mA}$	3.2	5.0	Ω
		I <sub>F</sub> = 1 mA	2.3	3.6	Ω
		I <sub>F</sub> = 10 mA	1.1	1.8	Ω
		I <sub>F</sub> = 100 mA	8.0	1.3	Ω
S <sub>21</sub>   <sup>2</sup>	isolation	V <sub>R</sub> = 0; f = 900 MHz	15.7	_	dB
		V <sub>R</sub> = 0; f = 1800 MHz	10.8	-	dB
		V <sub>R</sub> = 0; f = 2450 MHz	8.7	_	dB
S <sub>21</sub>   <sup>2</sup>	insertion loss	$I_F = 0.5 \text{ mA}; f = 900 \text{ MHz}$	0.26	_	dB
		$I_F = 0.5 \text{ mA}$ ; $f = 1800 \text{ MHz}$	0.28	_	dB
		$I_F = 0.5 \text{ mA}; f = 2450 \text{ MHz}$	0.31	_	dB
S <sub>21</sub>   <sup>2</sup>	insertion loss	I <sub>F</sub> = 1 mA; f = 900 MHz	0.20	_	dB
		$I_F = 1 \text{ mA}; f = 1800 \text{ MHz}$	0.23	_	dB
		$I_F = 1 \text{ mA}$ ; $f = 2450 \text{ MHz}$	0.25	_	dB
s <sub>21</sub>   <sup>2</sup>	insertion loss	$I_F = 10 \text{ mA}; f = 900 \text{ MHz}$	0.15	_	dB
		$I_F = 10 \text{ mA}; f = 1800 \text{ MHz}$	0.18	_	dB
		$I_F = 10 \text{ mA}; f = 2450 \text{ MHz}$	0.21	_	dB
S <sub>21</sub>   <sup>2</sup>	insertion loss	$I_F = 100 \text{ mA}; f = 900 \text{ MHz}$	0.10	_	dB
		$I_F = 100 \text{ mA}; f = 1800 \text{ MHz}$	0.13	_	dB
		$I_F = 100 \text{ mA}; f = 2450 \text{ MHz}$	0.16	_	dB
$ au_{L}$	charge carrier life time	when switched from $I_F$ = 10 mA to $I_R$ = 6 mA; $R_L$ = 100 $\Omega$ ; measured at $I_R$ = 3 mA	0.5	_	μs
L <sub>S</sub>	series inductance	I <sub>F</sub> = 100 mA; f = 100 MHz	0.6	_	nH

## Note

1. Guaranteed on AQL basis: inspection level S4, AQL 1.0.

## THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R <sub>th j-s</sub>	thermal resistance from junction to soldering point		K/W

## Silicon PIN diode

## BAP1321-01

## **GRAPHICAL DATA**

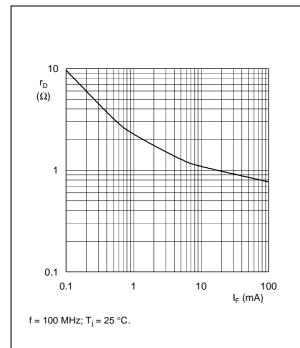


Fig.2 Forward resistance as a function of forward current; typical values.

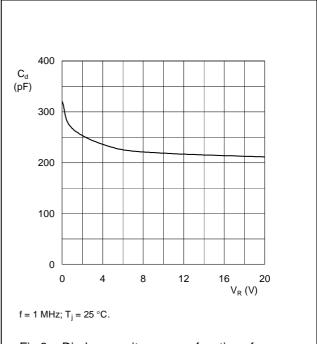
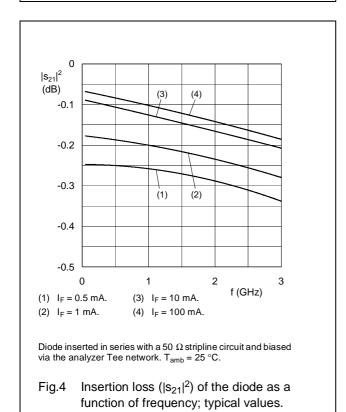
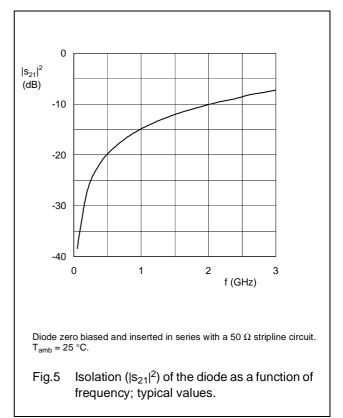


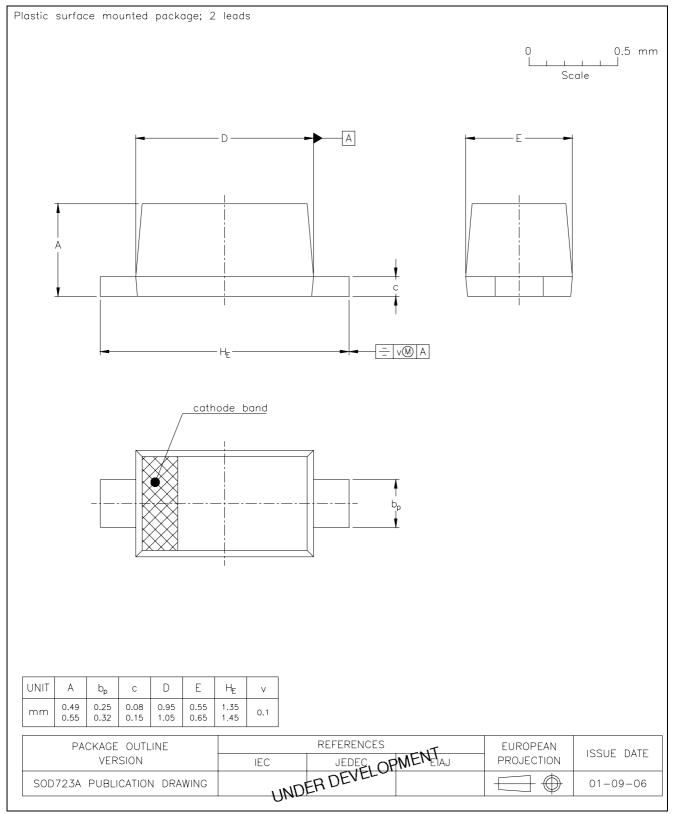
Fig.3 Diode capacitance as a function of reverse voltage; typical values.





## Silicon PIN diode BAP1321-01

## PACKAGE OUTLINE SOD723A



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Silicon PIN diode BAP1321-01

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DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITIONS
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